

MULTI-INNO TECHNOLOGY CO., LTD.

LCD MODULE SPECIFICATION

MODULE NO.: MI12864J-G-7

Revision	V1.0
Engineering	
Date	
Our Reference	



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RECORD OF REVISION

NO	REASON	DESCRIPTION OF CHANGES	REMARKS	DATE
0.1 1.0	Full Version	Original Version	Preliminary	20060901 20061023
1.0				



GENERAL INFORMATION

1. SCOPE:

This specification covers the delivery requirements for the LCM delivered by Multi-Inno Technology Co.,Ltd. to Customer.

2. PRODUCT ELEMENT

LCD, IC, BACKLIGHT, FPC

3. MODULE NAME

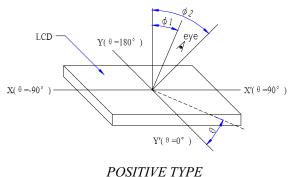
MI12864J-G-7

4. ENVIRONMENT DESCRIPTION.

RoHS COMPLIANT.

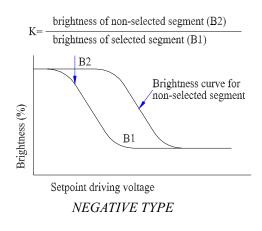
• OPTICAL DEFINITIONS

1. Definition of angle θ and ϕ

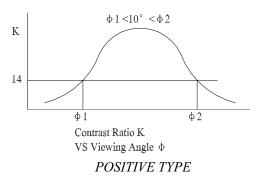


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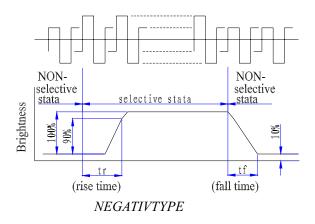
3. Definition of contrast "K"



2. Definition of viewing angle $\ \varphi \ 1 \ \mbox{and} \ \varphi \ 2$

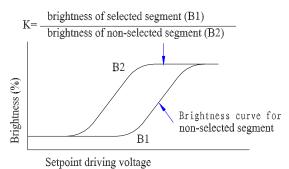


4. Definition of optical response

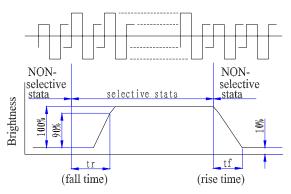




5. Definition of contrast "K"

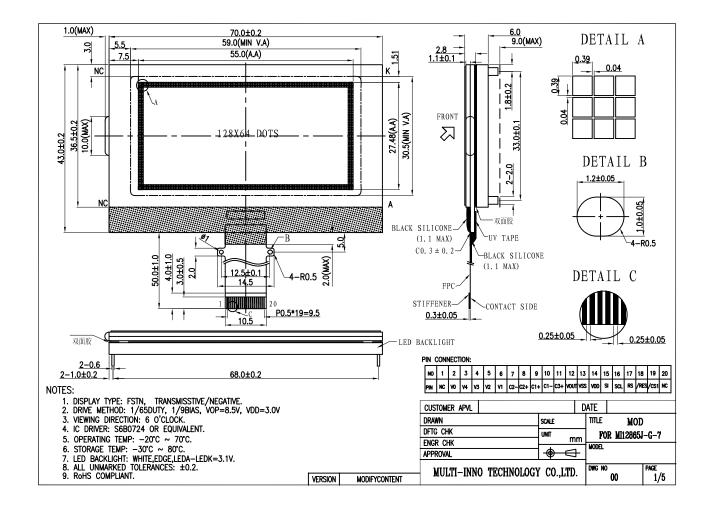


6. Definition of optical response



OUTLINE AND MECHANICAL DESCRIPTION

1. OUTLINE





PIN CONNECTION:

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
NC	V0	V4	V3	V2	V1	C2-	C2+	C1+	C1-	C3+	VOUT	VSS	VDD	S1	SCL	RS	/RES	/CS1	NC

2. MECHANICAL DESCRIPTION

Item.	Standard Value	Unit				
Lcm Size	$70L \times 93W \times 9.5H(MAX)$	mm				
Lcd Size	$70L \times 36.5W_1/43W_2 \times 2.8H$	mm				
Dot Size	0.39×0.39	mm				
Dot Number	128×64	dots				
Dot Pitch	0.43×0.43	mm				
Assy.Type	COG					
Effective Display Area	59×30.5	mm				
View Direction	□ 3H					
Lcd Type	□ TN □ HTN □ STN GRAY □ STN BLUE □ STN YELLOW-GREEN ■ FSTN B/W □ OTHER					
Display Mode	□ Positive					
Rear Polarizer	🗖 Reflective 🗖 Transflective 🔽 Transmissive					
Backlight Type	EL □ CCFL □ Bottom ■ Edge					
	Led Voltage: 3.1V Lightness: 250CD/M ²					
Backlight Color	\blacksquare White \square Yellow-Green \square Blue \square Amber \square Other					
Temperature Range	OP:-20°C~70°C ST:-30°C~80°C					
Duty	1/65					
Drive IC	S6B0724					
Weight	27	g				



• ELECTRICAL DESCRIPTION

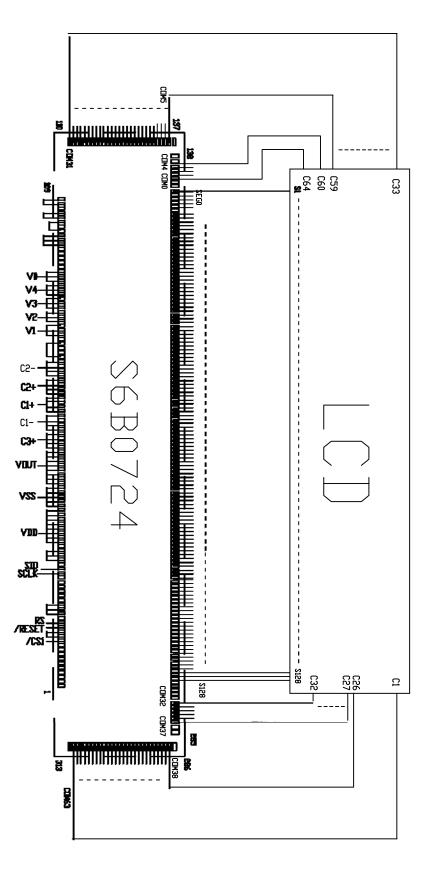
1. Input signal Function

Pin No.	Symbol	Level	Description
1	NC	-	No connection
2	V0	9.0V	
3	V4	-	
4	V3	-	Power supply voltage for LCD
5	V2	-	$V_0 \ge V_1 \ge V_2 \ge V_3 \ge V_4 \ge V_{SS}$
6	V1	-	
7	C2-	-	Capacitor pin for voltage converter
8	C2+	-	Capacitor pin for voltage converter
9	C1+	-	Capacitor pin for voltage converter
10	C1-	-	Capacitor pin for voltage converter
11	C3+	-	Capacitor pin for voltage converter
12	VOUT	-	DC/DC voltage converter output
13	VSS	0V	Ground
14	VDD	2.7~3.3V	Power supply voltage for logic
15	SI	H/L	Serial data input pin
16	SCL	H/L	Serial clock input pin
17	RS	H/L	Register select input pin H: Data, L: control
18	/RES	H/L	Reset input pin (active at low)
10	/CS1	H/L	Chip select input pin (active at low)
20	NC	-	No connection

2. Block diagram

Circuit Block Diagram





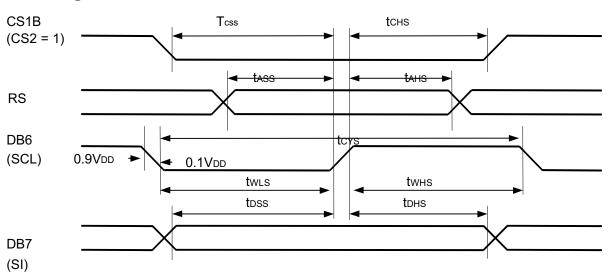
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Iter	m	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage		Vdd-Vss	2.7	3.0	3.3	v
Supply V	/oltage	Vlcd	-	9.0	-	V
Input	High	V _{IH}	0.8V _{DD}	-	V _{DD}	v
Signal V _{oltage}	Low	V _{IL}	0	-	$0.2 \mathrm{V_{DD}}$	V
Supply current (Logic) (Display character) Supply current (LED)		I _{dd}	-	200	-	uA
		\mathbf{I}_{EE}	-	-	80	mA

Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	Vdd-Vss	-0.3	6.0		
LCD Driving Voltage	Vlcd	-0.3	17.0	V	
Operating Temperature	Тор	-20	+70	ŝ	No
Storage Temperature	Тѕт	-30	+80	°C	Condensation





4. Timing Characteristics



	$(VDD = 2.4 \text{ to } 3.6\text{ V}, 1\text{ a} = -40 \text{ to } +85^{\circ}\text{C})$								
	Signal	Symbol	Min.	Тур.	Max.	Unit	Remark		
Serial clock cycle SCLK high pulse	DB6 (SCL)	TCYS tWHS tWLS	250 100 100	-	-	ns			
Address setup time Address hold time	RS	tASS tAHS	150 150	-	-	ns			
Data setup time Data hold time	DB7 (SI)	tDSS tDHS	100 100	-	-	ns			
CS1B setup time CS1B hold time	CS1B	tCSS tCHS	150 150	-	-	ns			

(VDD = 2	4 to 3.6V	Ta = -	40 to	+85°C)
۰.	VDD 2.	+ 10 0.0 V	, 10	40 10	.00.0)

MODEL NO.: MI12864J-G-7 FRUCTION DESCRIPTION

				1 aux		ructior		-			
Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description
Display ON / OFF	0	0	1	0	1	0	1	1	1	DON	Turn on/off LCD panel When DON = 0: display OFF When DON = 1: display ON
Initial display line	0	0	0	1	ST5	ST4	ST3	ST2	ST1	ST0	Specify DDRAM line for COM0
Set page address	0	0	1	0	1	1	P3	P2	P1	P0	Set page address
Set column address	0	0	0	0	0	1	Y7	Y6	Y5	Y4	Set column address MSB
Set column address	0	0	0	0	0	0	Y3	Y2	Y1	Y0	Set column address LSB
Read status	0	1	BUSY	ADC	0N0 ∏	RESETB	0	0	0	0	Read the internal status
Write display data	1	0				Write	e data				Write data into DDRAM
Read display data	1	1			_	Read	d data				Read data from DDRAM
ADC select	0	0	1	0	1	0	0	0	0	ADC	Select SEG output direction When ADC = 0: normal directio (SEG0→SEG131) When ADC = 1: reverse
Reverse display ON /	0	0	1	0	1	0	0	1	1	REV	di ti (SEG131 SEG0) Select normal / reverse disp When REV = 0: normal disp
Entire display ON /	0	0	1	0	1	0	0	1	0	EON	Select normal/entire display ON When EON = 0: normal display.
LCD bias select	0	0	1	0	1	0	0	0	1	BIAS	Select LCD bias
Set modify-read	0	0	1	1	1	0	0	0	0	0	Set modify-read mode
Reset modify-read	0	0	1	1	1	0	1	1	1	0	release modify-read mode
R	0	0	1	1	1	0	0	0	1	0	Initialize the internal functions
SHL select	0	0	1	1	0	0	SHL	×	×	×	Select COM output direction When SHL = 0: normal direction (COM0→COM63) When SHL = 1: reverse direction
Power control	0	0	0	0	1	0	1	VC	VR	VF	Control power circuit operation
Regulator resistor	0	0	0	0	1	0	0	R2	R1	R0	Select internal resistance ratio or regulator resistor
Set reference voltage	0	0	1	0	0	0	0	0	0	1	Set reference voltage mode
Set reference voltage	0	0	×	×	SV5	SV4	SV3	SV2	SV1	SV0	Set reference voltage register
Set static indicator	0	0	1	0	1	0	1	1	0	SM	Set static indicator mode
Set static indicator	0	0	×	×	×	×	×	×	S1	S0	Set static indicator register
Power save	-	-	-	-	-	-	-	-	-	-	Compound Instruction of display OFF and entire display ON

Table . Instruction Table



• QUALITY AND RELIABILITY

1. Test Condition

Test should be conducted under the following conditions:

Ambient Temperature: $25 \pm 5 \degree$

Humidity : $\underline{60 \pm 20\% \text{ RH}}$

2.Sampling Plan

Sampling method shall be in inspection level 2, normal inspection, and single sampling plan tables for normal tightened, and reduced inspection.

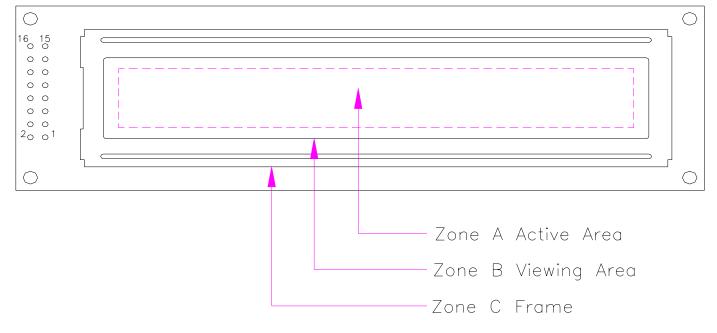
3.Acceptable Quality Level

A major defect is a defect that could result in failure or materially reduce that the usability of the unit of product for its intended purpose.

A minor defect is one that does not materially reduce the usability of the unit of product for its intended purpose or is a departure from established standards having no significant bearing on the effective use or operation of the unit.

4. Appearance and Checking Standard

Appearance test is to be conducted by eyes at approximately 30cm distance from LCD module under the single fluorescent light.





Item	项目	Figure 示意图	Criteria 判断标准	MA MI
Class	Glass Corner		 X≤3mm and don't touch pin X≤3mm 和不到达 PIN 的引线 Y out of seal resin Y 不进入框线 Z ignore ACC Z 不计 接收 	- MI
Glass Nonconform 一ity 玻璃不良	Breakage 角破损		 X≤1/8 Length of LCD side X≤1/8边长 Y out of area A Y不进入可视区 Z≤t Z don't touch seal resin ACC Z≤t Z 不到达框线 接收 	511
	Extra Glass Ledge 突出	TT	1、X ignore X不计 2、Y≤1/3 Length of conductor ACC Y≤1/3 PIN长 接收	MI
Glass Nonconform -ity 玻璃破损	Crack 裂缝		Any crack any where REJ 任何区域有裂痕 拒收	MA
			1	
Glass Nonconform	Glass Side		 X≤1/4 Length of LCD side X≤1/4边长 Y out of area A Y不进入可视区 Z≤t Z don't touch seal resin ACC Z≤t Z 不到达框线 接收 	
-ity 玻璃不良	Breakage 边破损	The second secon	 X≤1/4 Length of LCD side X≤1/4 LCD 边长 Y≤1/3 L(L: Length of conductor) Y≤1/3 PIN寬 Z≤t Z don't touch seal resin AC Z≤t Z 不到达框线 接□ 	
Color Va 彩			At most 2-color samples are acceptab but have no color difference in t brightest state. AC 无明显两色之分 接	he MI
Point Like flaw 点状不良			φ = (x+y) /2 φ ≤0.25mm ACC Distance between 2 spots≥5mm 接 φ = (x+y) /2 φ ≤0.25mm 两点间距 >5mm	
Scratching Line 线状刮伤		×	X≪6mm Y≤0.09mm ACC X≤6mm Y≤0.08mm 接	I MT



Polarizer Nonconform -ity 偏光片 不良	Deflectiv e Sticking 贴歪		According to the tolerance specified in engineering drawing, 符合工程图要求的公差 接收	
	Faulty Sticking 贴错		REJ 拒收	MA
	Air Bubble 气泡		Φ= (X+Y) / 2 Size (mm) Qty allowed 尺寸 允许个数 0.2<Φ≤0.5 2 Distance between 2 spots>5mm 两点间距>5mm Ignore if out of viewing area. 可视区外忽略不计	MI
Electrode & pin Nonconform -ity 电极与 PIN 脚不良	Pin Length PIN 长		Non-conformity with engineering drawing REJ 与工程图不符 拒收	MA
	Pin Deflec- tion PIN 歪斜	90*	Deviation exceeds 5 degree REJ 偏差>5 ⁰ 拒收 According to the tolerance specified in engineering drawing 若工程图有规定范围,则依图面规格	MI
	Pin body With resin PIN 上有胶		REJ 拒收	MI
	Deflec- tion Frame Lines 切斜		Deviation between two ends exceeds 0.25mm REJ 两端相差 0.25mm 拒收	MI

Contact Pad Unclean 导电层不洁	REJ 拒收	MI
Silk Printing Nonconformity 表面丝印不良	 Unspecified tolerance of width of line≤1/4 width. ACC 线宽均匀性≤1/4 线宽 接收 Silk printing location: According to the Tolerance specified in engineering drawing 丝印位置依工程图要求的公差 Diameter of broken pattern≤0.25mm. ACC 缺失图案直径≤0.25mm. 接收 	MI



5. Inspection Quality Criteria

ITME	DESCRIPTION OF DEFECTS			Class of defects	Acceptable level (%)
FUNCTION	Short circuit or Pattern cut			Major	0.65
DIMENSION	Refer to individual acceptance specification			Major	2.5
	Ave. Dia. D	area A	area B		
	D≤0.2	Disregard			
BLACK SPOTS	0.2 <d≤0.3< td=""><td>2</td><td>3</td><td>Minor</td><td>2.5</td></d≤0.3<>	2	3	Minor	2.5
	0.3 <d≤0.4< td=""><td>0</td><td>1</td><td>1</td><td></td></d≤0.4<>	0	1	1	
	0.4 <d< td=""><td>0</td><td>0</td><td></td><td></td></d<>	0	0		
	Width W, Length L	А	В		
	W≤0.03	W≤0.03 Disregard			
BLACK LINES	0.03 <w≤0.05< td=""><td>3</td><td>4</td><td>Minor</td><td>2.5</td></w≤0.05<>	3	4	Minor	2.5
	0.05 <w≤0.07, l≤3.0<="" td=""><td>1</td><td>1</td><td></td><td></td></w≤0.07,>	1	1		
BUBBLES IN	Average diameter D				
POLARIZER	0.2 < D < 0.5mm for N = 4			Minor	2.5
TOLARIZER	0.5 < D < 0.7mm for N=1				
COLOR UNIFORMITY	Rainbow color or Newton ring			Minor	2.5
GLASS SCRATCHES	Obvious visible damage.		Minor	2.5	
VIEWING ANGLE	VIEWING ANGLE Refer to individual acceptance specification			Minor	2.5
CONTRAST RATIO	Refer to individual accept	ndividual acceptance specification		Minor	2.5
RESPONSE TIME	Refer to individual acceptance specification			Minor	2.5

6. Reliability

The LCD module should have no failure in the following reliability test.

TEST ITEM	TEST CONDITIONS
HIGH TEMPERATURE STORAGE	80°C, 200hr.
LOW TEMPERATURE STORAGE	-30°C, 200hr
HUMIDITY STORAGE	80°C, 90%RH, 96hr.
HIGH TEMPERATURE OPERATION	70°C, typical operating conditions, 200hr.
LOW TEMPERATURE OPERATION	-20°C, typical operating conditions, 200hr.
TEMPERATURE CYCLING	-20 °C ~70 °C 10min, between each step temp. 50min, at each step temp. 5 cycles.
MECHANICAL VIBRATION	$10 \sim 100$ Hz sweep, 4G, amp1 = 10 mm(max) XYZ for 60min, each.
MECHANICAL SHOCK	10 ~ 55Hz, 50G. XYZ for 1 time, each.



NOTE 2: The module shelled be inspected after 1 hour storage in

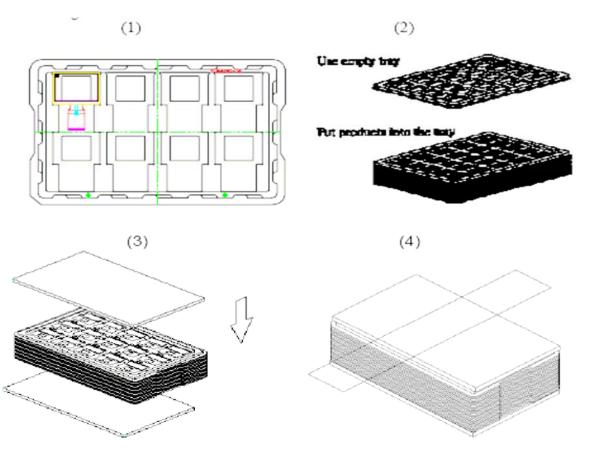
normal conditions (15~35°C, 45~65%RH).

PACKING

1. Packing Materials

No.	ITEM	DIMERSION(L*W*H)
1		
2		

2. Packing Method





(5)(6)Fix by adhesion tape. (7)(8)seal bending tape lable

- (1). Put module into tray cavity :
- (2). Tray stacking
- (3). Put 1 cardboard under the tray stack and 1 cardboard above:
- (4). Fix the cardboard to the tray stack with adhesive tape:
- (5). Put the tray stack and 4 pcs desiccant into the LDPE bag
- (6). Fix the LDPE bag with adhesive tape:
- (7). Put LDPE bag with tray stack into carton .:
- (8). Carton sealing with adhesive tape.



• CAUTION FOR USING LCM

1. **Precautions in handling LCD Modules**

Lcms have been assembled and accurately calibrated before delivery.

Please observe the following criteria when handling.

- A. Do not subject the module to excessive shock.
- B. Do not modify the tab on the metal holder.
- C. Do not tamper with the printed circuit board.
- **D.** Limit the soldering of the printed circuit board to I/O terminals only.

Do not touch the zebra strip nor modify its location.

2. Static electricity warning

LCM uses CMOS LSI technology. Therefore, strict measures to avoid static electricity discharge are followed through all processes from manufacturing to shipping. When handling a LCM, take sufficient care to prevent static electricity discharge as you would any CMOS IC.

A. Do not take the LCM from its anti-static bag until it's to be assembled.

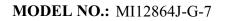
LCMs are individually packaged in bags specially treated to resist static electricity. When storing, keep the LCM packed in the original bags, or store them in a container processed to be resistant to static electricity, or in an electric conductive container.

B. Always use a ground strap when handling a LCM.

Always use a ground strap while working with the module, from the time it is taken out of the anti-static bag until it is assembled. If it is necessary to transfer the LCM, once it has been taken out of the bag, always place it in an electric conductive container. Avoid wearing clothes made of chemical fibers, the use of cotton or conductive treated fiber clothing is recommended.

C. Use a no-leak iron for soldering the LCM.

The soldering iron to be used for soldering the I/O terminals to the LCM are to be insulated or grounded at the iron tip.





D. Always ground electrical apparatuses required for assembly.

Electrical apparatuses required to assemble the LCM into a product, i.e. electrical screw drivers, are to be first grounded to avoid transmitting spike noises from the motor.

E. Assure that the work bench is properly grounded.

F: Peel off the LCM protective film slowly.

The module is attached with a film to protect the display surface from contamination, damage, adhesion of flux, etc. Peeling off this film abruptly could cause static electricity to be generated, so peel the tape slowly.

G: Pay attention to the humidity in the work area. 50~60% RH is recommended.

3. Storage

If the correct method of storage is not followed, deterioration of the display material (polarizer) and oxidation of the I/O terminal plating may make the process of soldering difficult. Please comply with the following procedure.

A. Store in the shipping container.

- B. If the shipping container is not available, place in anti-static bags and seal the opening.
- C. Store the modules where they are not subjected to direct sunlight or a fluorescent lamp.
- D. Store in a temperature range of 0° C 35°C with low relative humidity.

4. Caution

- A. Do not give any external shock.
- B. Do not wipe the surface with hard materials.
- C. Do not apply excessive force on the surface.
- D. Do not expose to direct sunlight or fluorescent light for a long time.
- E. Avoid storage in high temperature and high humidity.

F. When storage for a long time at 40° C or higher is required, R/H should be less than 60%. Liquid in LCD is hazardous substance. Do not lick, swallow when the liquid is attached to your hands, skin, clothes etc. Wash it out thoroughly.